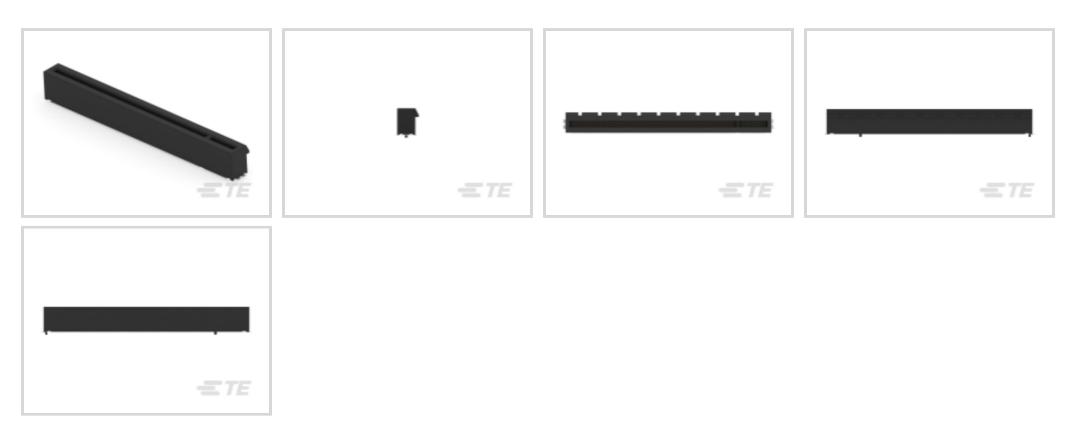
1-2364427-4 ACTIVE

TE Internal #: 1-2364427-4 PCI & PCI Express Connectors, Board-to-Board, 164 Position, .04 in [1 mm] Centerline, Vertical, Black, Height 11.25 mm [.44 in], Width 8.2 mm [.32 in]

### View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors



Connector System: Board-to-Board

Number of Positions: 164

PCI Generation: 5

Centerline (Pitch): 1 mm [.04 in ]

Termination Post & Tail Length: 1.1 mm [.043 in ]

## Features

### Product Type Features

Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	164
PCB Mount Orientation	Vertical
Ejector	Without
Contact Features	
	15 µin
Contact Current Rating (Max)	1.1 A
Termination Features	
Termination Method to Printed Circuit Board	Surface Mount
Termination Post & Tail Length	1.1 mm[.043 in]
Mechanical Attachment	

**C** For support call+1 800 522 6752

### 1-2364427-4

PCI & PCI Express Connectors, Board-to-Board, 164 Position, .04 in [1 mm] Centerline, Vertical, Black, Height 11.25 mm [.44 in], Width 8.2 mm [.32 in]



Metal Hold-Down
Metal Hold-Down
Board Mount
1 mm[.04 in]
Black
11.25 mm[.44 in]
8.2 mm[.32 in]
-40 – 85 °C[-40 – 185 °F]
High Speed Data
5

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Soldar Process Canability	Not reviewed for colder process capability

Solder Process Capability

Not reviewed for solder process capability

### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits

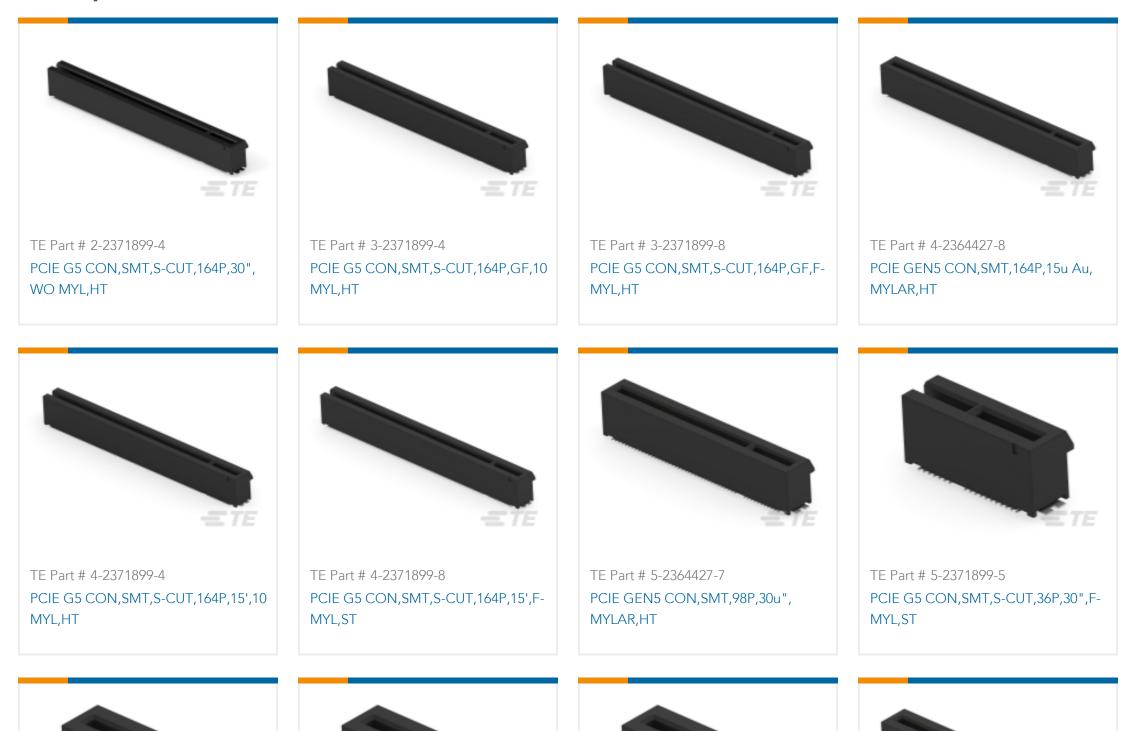
### 1-2364427-4

PCI & PCI Express Connectors, Board-to-Board, 164 Position, .04 in [1 mm] Centerline, Vertical, Black, Height 11.25 mm [.44 in], Width 8.2 mm [.32 in]



as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

# **Compatible Parts**





## Documents

Product Drawings PCIE G5 CON,SMT,164P,15",WO MYLAR,HT

English

### 1-2364427-4

PCI & PCI Express Connectors, Board-to-Board, 164 Position, .04 in [1 mm] Centerline, Vertical, Black, Height 11.25 mm [.44 in], Width 8.2 mm [.32 in]



CAD Files Customer View Model ENG\_CVM\_CVM\_1-2364427-4\_A.3d\_igs.zip English Customer View Model ENG\_CVM\_CVM\_1-2364427-4\_A.3d\_stp.zip English Customer View Model ENG\_CVM\_CVM\_1-2364427-4\_A.2d\_dxf.zip English 3D PDF

**Product Specifications** 

**Application Specification** 

English